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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Low Voltage 2.5/3.3 V Differential ECL/PECL/HSTL Fanout Buffer

The MC100ES6210 is a bipolar monolithic differential clock fanout buffer. Designed for most demanding clock distribution systems, the MC100ES6210 supports various applications that require to distribute precisely aligned differential clock signals. Using SiGe technology and a fully differential architecture, the device offers very low clock skew outputs and superior digital signal characteristics. Target applications for this clock driver is high performance clock distribution in computing, networking and telecommunication systems.

Features

- · Dual 1:5 differential clock distribution
- · 30 ps maximum device skew
- · Fully differential architecture from input to all outputs
- · SiGe technology supports near-zero output skew
- Supports DC to 3 GHz operation of clock or data signals
- ECL/PECL compatible differential clock outputs
- ECL/PECL compatible differential clock inputs
- Single 3.3 V, –3.3 V, 2.5 V or –2.5 V supply
- Standard 32 lead LQFP package
- Industrial temperature range
- Pin and function compatible to the MC100EP210
- · 32-lead Pb-free Package Available

MC100ES6210

LOW VOLTAGE DUAL

1:5 DIFFERENTIAL PECL/ECL/HSTL
CLOCK FANOUT BUFFER



FA SUFFIX 32-LEAD LQFP PACKAGE CASE 873A-03



AC SUFFIX
32-LEAD LQFP PACKAGE
Pb-FREE PACKAGE
CASE 873A-03

Functional Description

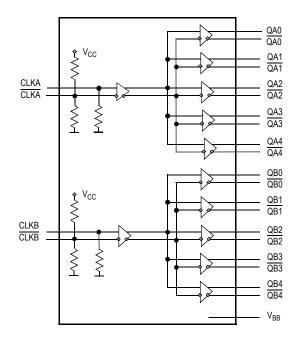
The MC100ES6210 is designed for low skew clock distribution systems and supports clock frequencies up to 3 GHz. The device consists of two independent 1:5 clock fanout buffers. The input signal of each fanout buffer is distributed to five identical, differential ECL/PECL outputs. Both CLKA and CLKB inputs can be driven by ECL/PECL compatible signals.

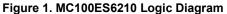
If V_{BB} is connected to the CLKA or CLKB input and bypassed to GND by a 10 nF capacitor, the MC100ES6210 can be driven by single-ended ECL/PECL signals utilizing the V_{BB} bias voltage output.

In order to meet the tight skew specification of the device, both outputs of a differential output pair should be terminated, even if only one output is used. In the case where not all ten outputs are used, the output pairs on the same package side as the parts being used on that side should be terminated.

The MC100ES6210 can be operated from a single 3.3 V or 2.5 V supply. As most other ECL compatible devices, the MC100ES6210 supports positive (PECL) and negative (ECL) supplies. The is function and pin compatible to the MC100EP210.







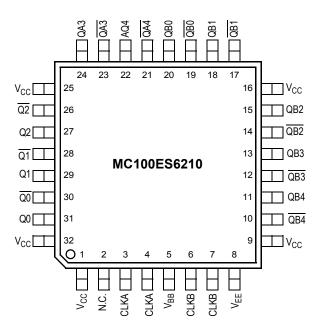


Figure 2. 32-Lead Package Pinout (Top View)

Table 1. Pin Configuration

Pin	I/O	Туре	Function
CLKA, CLKA	Input	ECL/PECL	Differential reference clock signal input (fanout buffer A)
CLKB, CLKB	Input	ECL/PECL	Differential reference clock signal input (fanout buffer B)
QA[0-4], QA[0-4]	Output	ECL/PECL	Differential clock outputs (fanout buffer A)
QB[0-4], QB[0-4]	Output	ECL/PECL	Differential clock outputs (fanout buffer B)
V _{EE} ⁽¹⁾	Supply		Negative power supply
V _{CC}	Supply		Positive power supply. All $V_{\rm CC}$ pins must be connected to the positive power supply for correct DC and AC operation.
V _{BB}	Output	DC	Reference voltage output for single ended ECL or PECL operation

^{1.} In ECL mode (negative power supply mode), V_{EE} is either –3.3 V or –2.5 V and V_{CC} is connected to GND (0 V). In PECL mode (positive power supply mode), V_{EE} is connected to GND (0 V) and V_{CC} is either +3.3 V or +2.5 V. In both modes, the input and output levels are referenced to the most positive supply (V_{CC})

Table 2. Absolute Maximum Ratings⁽¹⁾

Symbol	Characteristics	Min	Max	Unit	Condition
V _{CC}	Supply Voltage	-0.3	3.6	V	
V _{IN}	DC Input Voltage	-0.3	V _{CC} + 0.3	V	
V _{OUT}	DC Output Voltage	-0.3	V _{CC} + 0.3	V	
I _{IN}	DC Input Current		±20	mA	
I _{OUT}	DC Output Current		±50	mA	
T _S	Storage temperature	-65	125	°C	

^{1.} Absolute maximum continuous ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation at absolute-maximum-rated conditions is not implied.

Table 3. General Specifications

Symbol	Characteristics	Min	Тур	Max	Unit	Condition
V _{TT}	Output Termination Voltage		$V_{CC} - 2^{(1)}$		V	
MM	ESD Protection (Machine Model)	200			V	
HBM	ESD Protection (Human Body Model)	2000			V	
CDM	ESD Protection (Charged Device Model)				V	
LU	Latch-Up Immunity	200			mA	
C _{IN}	Input Capacitance		4.0		pF	Inputs
θЈΑ	Thermal Resistance Junction to Ambient JESD 51-3, single layer test board JESD 51-6, 2S2P multilayer test board		83.1 73.3 68.9 63.8 57.4 59.0 54.4 52.5 50.4 47.8	86.0 75.4 70.9 65.3 59.6 60.6 55.7 53.8 51.5 48.8	°C/W °C/W °C/W °C/W °C/W °C/W °C/W °C/W	Natural convection 100 ft/min 200 ft/min 400 ft/min 800 ft/min Natural convection 100 ft/min 200 ft/min 400 ft/min 800 ft/min
θJC	Thermal Resistance Junction to Case		23.0	26.3	°C/W	MIL-SPEC 883E Method 1012.1
T _J	Operating Junction Temperature ⁽²⁾ (continuous operation) MTBF = 9.1 years			110	°C	

^{1.} Output termination voltage V_{TT} = 0 V for V_{CC} = 2.5 V operation is supported but the power consumption of the device will increase.

Table 4. PECL DC Characteristics (V_{CC} = 2.5 V \pm 5% or V_{CC} = 3.3 V \pm 5%, V_{EE} = GND, T_J = 0°C to +110°C)

Symbol	Characteristics	Min	Тур	Max	Unit	Condition
Clock Input	Pair CLKA, CLKA, CLKB, CLKB (PECL difference	ential signals)		1		-
V _{PP}	Differential Input Voltage ⁽¹⁾	0.1		1.3	V	Differential operation
V_{CMR}	Differential Cross Point Voltage ⁽²⁾	1.0		V _{CC} - 0.3	V	Differential operation
I _{IN}	Input Current ⁽¹⁾			±100	μΑ	$V_{IN} = V_{IL}$ or $V_{IN} = V_{IH}$
PECL Clock Outputs (QA0-4, QA0-4, QB0-4, QB0-4)						
V _{OH}	Output High Voltage	V _{CC} -1.2	V _{CC} -1.005	V _{CC} -0.7	V	$I_{OH} = -30 \text{ mA}^{(3)}$
V _{OL}	Output Low Voltage V_{CC} = 3.3 V±5% V_{CC} = 2.5 V±5%	V _{CC} –1.9 V _{CC} –1.9	V _{CC} -1.705 V _{CC} -1.705	V _{CC} -1.5 V _{CC} -1.3	V	$I_{OL} = -5 \text{ mA}^{(3)}$
Supply Curr	ent and V _{BB}					
I _{EE}	I _{EE} Maximum Quiescent Supply Current without Output Termination Current		60	100	mA	V _{EE} pin
V _{BB}	Output Reference Voltage	V _{CC} -1.38	V _{CC} -1.26	V _{CC} -1.14	V	I _{BB} = 0.2 mA

^{1.} V_{PP} (DC) is the minimum differential input voltage swing required to maintain device functionality.

^{2.} Operating junction temperature impacts device life time. Maximum continuous operating junction temperature should be selected according to the application life time requirements (See application note AN1545 for more information). The device AC and DC parameters are specified up to 110°C junction temperature allowing the MC100ES6210 to be used in applications requiring industrial temperature range. It is recommended that users of the MC100ES6210 employ thermal modeling analysis to assist in applying the junction temperature specifications to their particular application.

^{2.} V_{CMR} (DC) is the crosspoint of the differential input signal. Functional operation is obtained when the crosspoint is within the V_{CMR} (DC) range and the input swing lies within the V_{PP} (DC) specification.

^{3.} Equivalent to a termination of 50 Ω to V $_{\mbox{\scriptsize TT}}$

Table 5. ECL DC Characteristics (V_{EE} = –2.5 V \pm 5% or V_{EE} = –3.3 V \pm 5%, V_{CC} = GND, T_J = 0°C to +110°C)

Symbol	Characteristics	Min	Тур	Max	Unit	Condition		
Clock Input I	Clock Input Pair CLKA, CLKA, CLKB, CLKB (ECL differential signals)							
V _{PP}	Differential Input Voltage ⁽¹⁾	0.1		1.3	V	Differential operation		
V_{CMR}	Differential Cross Point Voltage ⁽²⁾	V _{EE} + 1.0		-0.3	V	Differential operation		
I _{IN}	Input Current ⁽¹⁾			±100	μА	$V_{IN} = V_{IL}$ or $V_{IN} = V_{IH}$		
ECL Clock C	ECL Clock Outputs (QA0-4, QA0-4, QB0-4, QB0-4)							
V _{OH}	Output High Voltage	-1.2	-1.005	-0.7	V	$I_{OH} = -30 \text{ mA}^{(3)}$		
V _{OL}	Output Low Voltage V_{CC} = 3.3 V $\pm 5\%$ V_{CC} = 2.5 V $\pm 5\%$	-1.9 -1.9	-1.705 -1.705	-1.5 -1.3	V	$I_{OL} = -5 \text{ mA}^{(3)}$		
Supply Curre	ent and V _{BB}			•	•			
I _{EE}	Maximum Quiescent Supply Current without Output Termination Current		60	100	mA	V _{EE} pin		
V_{BB}	Output Reference Voltage	-1.38	-1.26	-1.14	V	I _{BB} = 0.2 mA		

V_{PP} (DC) is the minimum differential input voltage swing required to maintain device functionality.
 V_{CMR} (DC) is the crosspoint of the differential input signal. Functional operation is obtained when the crosspoint is within the V_{CMR} (DC) range and the input swing lies within the V_{PP} (DC) specification.

^{3.} Equivalent to a termination of 50 Ω to V $_{TT}$

Table 6. AC Characteristics (ECL: V_{EE} = $-3.3~V \pm 5\%$ or V_{EE} = $-2.5~V \pm 5\%$, V_{CC} = GND) or (PECL: V_{CC} = $3.3~V \pm 5\%$ or V_{CC} = $2.5~V \pm 5\%$, V_{EE} = GND, T_J = 0° C to +110°C)⁽¹⁾ (2)

Symbol	Characteristics	Min	Тур	Max	Unit	Condition
Clock Input	Pair CLKA, CLKA, CLKB, CLKB (PECL or ECL diffe	erential signals)			•	
V _{PP}	Differential Input Voltage ⁽³⁾ (peak-to-peak)	0.3	0.3	1.3	V	
V _{CMR}	Differential Input Crosspoint Voltage ⁽⁴⁾ PECL ECL	1.2 V _{EE} + 1.2		V _{CC} - 0.3 -0.3 V	V	
ECL Clock C	Outputs (Q0–9, Q0–9)			1		1
f _{CLK}	Input Frequency	0		3000	MHz	Differential
t _{PD}	Propagation Delay CLKA to QAx or CLKB to QBx	175	260	350	ps	Differential
V _{O(P-P)}	Differential Output Voltage (peak-to-peak) $f_O < 1.1 \; \text{GHz} \\ f_O < 2.5 \; \text{GHz} \\ f_O < 3.0 \; \text{GHz}$	0.45 0.35 0.20	0.70 0.55 0.35		V V V	
t _{sk(O)}	Output-to-Output Skew (per bank)		13	30	ps	Differential
t _{sk(PP)}	Output-to-Output Skew (part-to-part)			175	ps	Differential
t _{JIT(CC)}	Output Cycle-to-Cycle Jitter			1	ps	
t _{SK(P)}	Output Pulse Skew ⁽⁵⁾			50	ps	
DC_Q	Output Duty Cycle $f_{REF} < 0.1 \text{ GHz}$ $f_{REF} < 1.0 \text{ GHz}$	49.5 45.0	50 50	50.5 55.0	% %	DC _{REF} = 50% DC _{REF} = 50%
t _r , t _f	Output Rise/Fall Time	30		250	ps	20% to 80%

- 1. AC characteristics are design targets and pending characterization.
- 2. AC characteristics apply for parallel output termination of 50 Ω to V_{TT}.
- 3. V_{PP} (AC) is the minimum differential ECL/PECL input voltage swing required to maintain AC characteristics including t_{PD} and device-to-device skew.
- 4. V_{CMR} (AC) is the crosspoint of the differential ECL/PECL input signal. Normal AC operation is obtained when the crosspoint is within the V_{CMR} (AC) range and the input swing lies within the V_{PP} (AC) specification. Violation of V_{CMR} (AC) or V_{PP} (AC) impacts the device propagation delay, device and part-to-part skew.
- 5. Output pulse skew is the absolute difference of the propagation delay times: $|t_{PLH}-t_{PHL}|$.

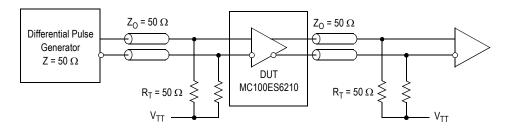
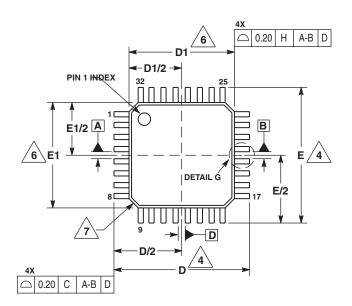
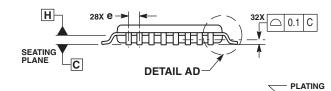
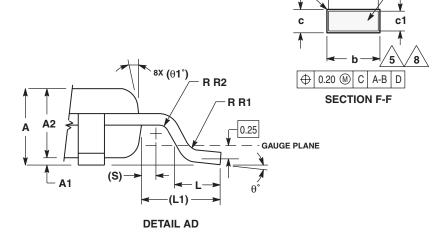


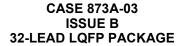
Figure 3. MC100ES6210 AC Test Reference

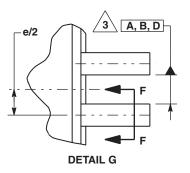
PACKAGE DIMENSIONS











- NOTES:

 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

 3. DATUMS A, B, AND D TO BE DETERMINED AT DATUM PLANE H.

 4. DIMENSIONS D AND E TO BE DETERMINED AT SEATING PLANE C.

 5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION: 0.07-mm.

 6. DIMENSIONS DI AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25-mm PER SIDE. DI AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.

 2. EXACT SHAPE OF EACH CORNER IS OPTIONAL.

 8. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1-mm AND 0.25-mm FROM THE LEAD TIP.

	MILLIMETERS				
DIM	MIN	MAX			
Α	1.40	1.60			
A1	0.05	0.15			
A2	1.35	1.45			
b	0.30	0.45			
b1	0.30	0.40			
С	0.09	0.20			
c1	0.09	0.16			
D	9.00 BSC				
D1	7.00 BSC				
е	0.80 BSC				
Е	9.00 BSC				
E1	7.00	BSC			
L	0.50	0.70			
L1	1.00 REF				
q	0° 7°				
q1	12 REF				
R1	0.08	0.20			
R2	0.08				
S	0.20 REF				

NOTES

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E-mail:

support@freescale.com

USA/Europe or Locations Not Listed:

Freescale Semiconductor Technical Information Center, CH370 1300 N. Alma School Road Chandler, Arizona 85224 +1-800-521-6274 or +1-480-768-2130 support@freescale.com

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH Technical Information Center Schatzbogen 7 81829 Muenchen, Germany +44 1296 380 456 (English) +46 8 52200080 (English) +49 89 92103 559 (German) +33 1 69 35 48 48 (French) support@freescale.com

Japan:

Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku, Tokyo 153-0064 Japan 0120 191014 or +81 3 5437 9125 support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd. Technical Information Center 2 Dai King Street
Tai Po Industrial Estate
Tai Po, N.T., Hong Kong
+800 2666 8080
support.asia@freescale.com

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